

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	DRYING PROCESS FOR WAFERS
Application Type : regular, utility Attorney Docket Number : NAUP0569USA	
Correspondence address: Customer Number: 027765 	
Inventors Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: TW Given Name: Chien-Hua Family Name: Tsai Residence: City of Residence: Tai-Chung City Country of Residence: TW Address-1 of Mailing Address: 9F-3, No. 117-1, Hsing-Chin Rd., North District Address-2 of Mailing Address: City of Mailing Address: Tai-Chung City State of Mailing Address: Postal Code of Mailing Address: Country of Mailing Address: TW Phone: Fax: E-mail:	
<u>Inventor 2:</u> Applicant Authority Type: Inventor Citizenship: TW Given Name: Yi-Chin Family Name: WU Residence: City of Residence: Kao-Hsiung City	

Country of Residence: TW
Address-1 of Mailing Address: No. 1, Lane 83, Ling-Ya II Rd., Community 9,
Address-2 of Mailing Address: Gu-Chung Li, Ling-Ya District
City of Mailing Address: Kao-Hsiung City
State of Mailing Address:
Postal Code of Mailing Address:
Country of Mailing Address: TW
Phone:
Fax:
E-mail:

Inventor 3:

Applicant Authority Type: Inventor
Citizenship: TW
Given Name: Yen-Shen
Family Name: WEI
Residence:
City of Residence: Hsin-Chu City
Country of Residence: TW
Address-1 of Mailing Address: No. 16, Lane 1451, Sec. 2, Yan-Ping Rd.,
Address-2 of Mailing Address: Hsian-Shan District
City of Mailing Address: Hsin-Chu City
State of Mailing Address:
Postal Code of Mailing Address:
Country of Mailing Address: TW
Phone:
Fax:
E-mail:

Attorney Information:

practitioner(s) at Customer Number:

027765



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.